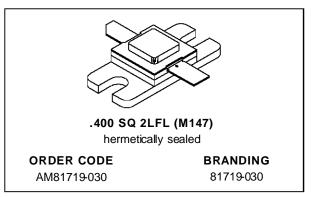


### AM81719-030

# RF & MICROWAVE TRANSISTORS TELEMETRY APPLICATIONS

PRELIMINARY DATA

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- P<sub>OUT</sub> = 28 W MIN. WITH 6.7 dB GAIN

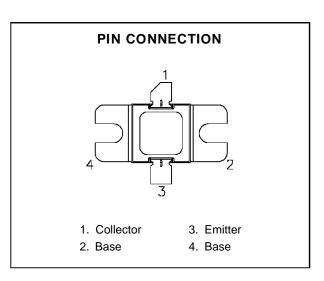


#### **DESCRIPTION**

The AM81719-030 is a high power silicon NPN bipolar transistor designed for Class C, CW communications and telemetry applications in the 1.75 - 1.85 GHz frequency range.

An emitter site ballasted refractory/gold overlay die geometry computerized automatic wire bonding is employed to ensure long term reliability and product consistency.

AM81719-030 is supplied in the industry-standard AMPAC  $^{\scriptscriptstyle TM}$  hermetic metal/ceramic package.



#### **ABSOLUTE MAXIMUM RATINGS** $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
Poiss	Power Dissipation*	67.3	W
Ic	Device Current*	2.67	А
Vcc	Collector-Supply Voltage*	28	V
TJ	Junction Temperature	200	°C
T <sub>STG</sub>	Storage Temperature	- 65 to +200	°C

#### THERMAL DATA

R <sub>TH(j-c)</sub>	Junction-Case Thermal Resistance*	2.6	°C/W
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<sup>\*</sup>Applies only to rated RF amplifier operation

September 1992

#### **ELECTRICAL SPECIFICATIONS** (Tcase = 25°C)

#### STATIC

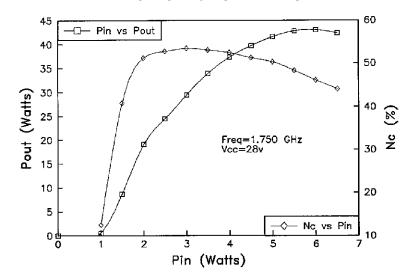
Symbol	Test Conditions	Value			IIm:4		
		Min.	Тур.	Max.	Unit		
BV <sub>CBO</sub>	I <sub>C</sub> = 10mA	$I_{E} = 0mA$		45	_	_	V
BV <sub>EBO</sub>	I <sub>E</sub> = 10mA	I <sub>C</sub> = 0mA		3.0	_	_	V
BVces	IC = 10mA			45	_	_	V
ICES	V <sub>BE</sub> = 0V	$V_{CE} = 28V$		_	_	5	mA
h <sub>FE</sub>	V <sub>CE</sub> = 5V	I <sub>C</sub> = 2mA		15	_	150	_

#### **DYNAMIC**

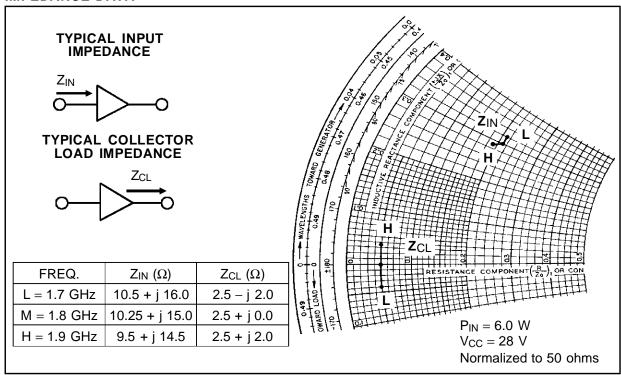
Symbol	Test Conditions		Value		Unit		
Syllibol	rest Conditions			Min.	Тур.	Max.	
Pout	f = 1.75 — 1.85GHz	$P_{\text{IN}} = 6.0 \text{W}$	$V_{CC} = 28V$	28	_	_	W
ης	f = 1.75 — 1.85GHz	$P_{IN} = 6.0W$	$V_{CC} = 28V$	40	_	_	%
G <sub>P</sub>	f = 1.75 — 1.85GHz	$P_{IN} = 6.0W$	V <sub>CC</sub> = 28V	6.7	_	_	dB

#### **TYPICAL PERFORMANCE**

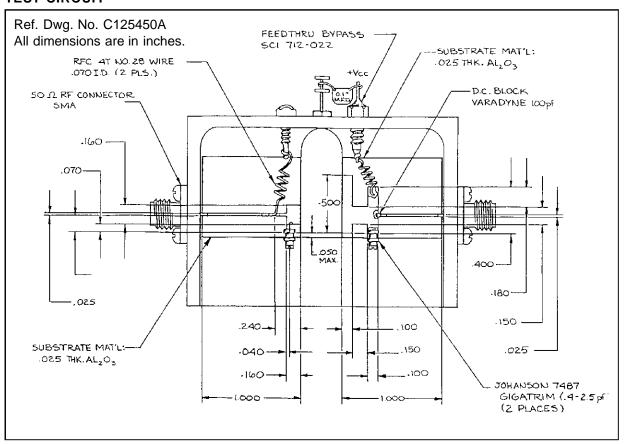
## POWER OUTPUT & COLLECTOR EFFICENCY vs POWER INPUT



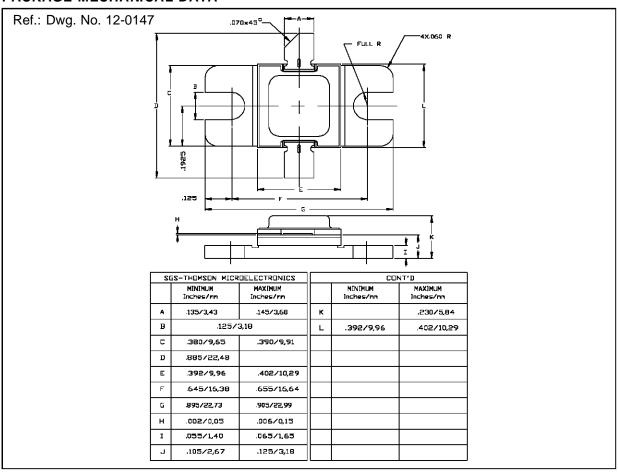
#### **IMPEDANCE DATA**



#### **TEST CIRCUIT**



#### PACKAGE MECHANICAL DATA



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